CLAIMS

1. A polyamide resin composition comprising polyamide resin and swelling mica treated with a polyether compound, wherein the polyether compound is represented by general formula (1):

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(wherein -A- represents -O-, -S-, -SO-, -SO₂-, -CO-, an alkylene group having 1 to 20 carbon atoms, or alkylidene group having 6 to 20 carbon atoms; and R^1 , R^2 , R^3 , R^4 , R^5 , R^6 , R^7 , and R^8 may be the same or different and each represent a hydrogen atom, a halogen atom, or a monovalent hydrocarbon group having 1 to 5 carbon atoms).

- The polyamide resin composition of claim 1, further
 comprising at least one of a styrene resin, an anhydridecontaining olefin copolymer, and a carbon compound.
 - 3. The polyamide resin composition of claim 1, further comprising a styrene resin.
 - 4. The polyamide resin composition of claim 1, further

comprising an anhydride-containing olefin copolymer.

- 5. The polyamide resin composition of claim 4, wherein the anhydride-containing olefin copolymer is obtained by copolymerization or graft reaction of olefin or an olefin copolymer with an alicyclic dicarboxylic anhydride having a cis double bond in the ring or an α,β -unsaturated dicarboxylic anhydride.
- 10 6. The polyamide resin composition of claim 4, wherein the content of the anhydride-containing olefin copolymer in the polyamide resin composition is in the range of 1 to 30 percent by weight.
- 7. The polyamide resin composition of claim 1, further comprising a carbon compound.
 - 8. The polyamide resin composition of claim 7, wherein the carbon compound is in the form of particles.

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- 9. The polyamide resin composition of claim 7, wherein the carbon compound is fibrous.
- 10. The polyamide resin composition of any one of claims
 25 1 to 9, wherein the polyether compound is represented by

general formula (2):

$$R^{11}$$
 $+ OR^{9}$ $+ OR^{10}O$ $+ OR^{10}$

(wherein A, R^1 , R^2 , R^3 , R^4 , R^5 , R^6 , R^7 , and R^8 are the same as above; R^9 and R^{10} may be the same or different and each represent a divalent hydrocarbon group having 1 to 5 carbon atoms; R^{11} and R^{12} may be the same or different and each represent a hydrogen atom or a monovalent hydrocarbon group having 1 to 20 carbon atoms; m and n each represent the number of oxyalkylene repeating units; and $2 \le m + n \le 50$).

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11. The polyamide resin composition of any one of claims 1 to 10, wherein the ratio of the swelling mica having an equivalent circular diameter [D] of 300 nm or less in the composition is 20% or more.

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12. The polyamide resin composition of any one of claims 1 to 11, wherein the average of the equivalent circular diameter [D] of the swelling mica in the polyamide resin composition is 500 nm or less.

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13. The polyamide resin composition of any one of claims

- 1 to 12, wherein the average layer thickness of the swelling mica in the polyamide resin composition is 50 nm or less.
- 14. The polyamide resin composition of any one of claims

 1 to 13, wherein the maximum layer thickness of the swelling

 mica in the polyamide resin composition is 200 nm or less.
- 15. The polyamide resin composition of any one of claims
 1 to 14, wherein the number [N] of particles per unit weight
 10 ratio of the swelling mica in the polyamide resin
 composition is 30 or more.
- 16. The polyamide resin composition of any one of claims 1 to 15, wherein the average aspect ratio (layer 15 length/layer thickness) of the swelling mica in the polyamide resin composition is 10 to 300.
- 17. The polyamide resin composition of any one of claims 1 to 16, the content of the swelling mica in the polyamide 20 resin composition is in the range of 0.5 to 30 percent by weight.
 - 18. The polyamide resin composition of claim 1 or 2, prepared by mixing these components.

- 19. A method for making a polyamide resin composition, comprising melt-mixing the components of the polyamide resin composition set forth in claim 1 or 2.
- 5 20. A molded resin article entirely or partially composed of the polyamide resin composition according to one of claims 1 to 18.
- 21. The molded resin article according to claim 20 used10 in automobile parts.